

#### PCN# 20230508000.1 Qualification of RFAB as an additional Fab site option for select LBC7 devices Change Notification / Sample Request

Date:May 08, 2023To:TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your local Field Sales Representative.

PCN Team SC Business Services

# **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TPS62160DGKR	null
LP5912-2.5DRVR	null
TLV1117LV33DCYT	null
TPS27081ADDCR	null
TPS562219ADDFT	null
TPS62170DSGR	null
TPS560200DBVR	null
TLV1117LV33DCYR	null
TPS54227DRCT	null
TPS62170DSGT	null
UCC27531D	null
UCC27531DBVR	null
TPS54228DRCR	null
TPS562219ADDFR	null
TPS62110RSAR	null
TPS62110RSAT	null
TPS54228D	null
TPS54228DR	null
UCC27511ADBVR	null
UCC27531DBVT	null
TPS54308DDCR	null
TPS62111RSAT	null
TPS62160DGKT	null
UCC27536DBVT	null
UCC27537DBVT	null
TPS54308DDCT	null
TPS62112RSAT	null
LP5912-1.8DRVR LP5912-5.0DRVR UCC27537DBVR LP5912-1.0DRVT LP5912-2.8DRVT UCC27538DBVR SN1706011DDCR	null null null null null null
TPS62111RSAR	null
UCC27533DBVR	null
UCC27538DBVT	null
TPS54227DRCR	null
TPS62112RSAR	null
TPS562210ADDFR	null
TPS562210DDFR	null
SN1708041DDCR	null

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b> 20230508000.1 <b>PCN Date:</b>						ate:	May 08, 2023				
Title:         Qualification of RFAB as an additional Fab site option for select LBC7 devices											
Cust	Customer Contact: PCN Manager						Dept:			Quality Services	
Proposed 1 <sup>st</sup> Ship Date:						accep	Cample requests			Jun 8, 2023*	
		ests rece	eived	afte	r June 8, 20	23 wil	l not be	esu	ppo	rted.	
	nge Type:										
	Assembly 9 Design	site		Assembly Process Electrical Specification			tion		Assembly Materials Mechanical Specification		
	Test Site								Test Process		
	Wafer Bur	p Site		<ul> <li>Packing/Shipping/Labeling</li> <li>Wafer Bump Material</li> </ul>					-	Bump Process	
	Wafer Fab	•		$\boxtimes$							Fab Process
					Part number change						
					PCN E	<b>Detail</b> s	S				
Desc	ription of	Change									
Texas Instruments is pleased to announce the qualification of an additional fab (RFAB) site for selected devices as listed below in the product affected section.											
		Current F		te				\ddi		al Fab	
Cur	Current Fab Process Site		ess		Wafer Diameter		tional Site		Process		Wafer Diameter
	MIHO	LBC	27	-	200 mm RFAB				L	BC7	300 mm
Qual details are provided in the Qual Data Section.											
Reas	on for Ch	ange:									
	Continuity of Supply										
Antic	cipated in	pact on	Form	, Fit	, Function, (	Qua lity	or Reli	ia bi	lity	(positi	ve / negative):
None											
Chan	nges to pr	oduct ide	entifi	catio	on resulting	from t	his PCN	<b>1:</b>			
Fab	Site Info	mation:									
				Origin Code 20L)		Chip Site Country Code (21L)			Chip Site City		
MIHO8			МН8	JPN				Ibaraki			
RFAB					RFB	USA			Richardson		
Sample product shipping label (not actual product label) TEXAS INSTRUMENTS MADE IN: Malaysia 2DC: 20: MSL 2 /260C/1 YEAR SEAL DT 03/29/04 OFT: ITEM: 39 LBL: 5A (L)T0:1750 (not actual product label) (1P) SN74LS07NSR (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY (1T) 7523483S12 (P) (2D) CSO: SHE (21L) CCO:USA (2L) ASO: MLA (23L) ACO: MYS											
Prod	uct Affect	ed:									

LP5912-0.9DRVR	SN1708041DDCR	TPS54228DRCR	TPS62112RSAT
LP5912-0.9DRVT	SN1708041DDCT	TPS54228DRCT	TPS62160DGKR
LP5912-1.0DRVR	SN1711021DDCR	TPS54308DDCR	TPS62160DGKT
LP5912-1.0DRVT	SN1711021DDCT	TPS54308DDCT	TPS62170DSGR
LP5912-1.1DRVR	TLV1117LV33DCYR	TPS560200DBVR	TPS62170DSGT
LP5912-1.1DRVT	TLV1117LV33DCYT	TPS560200DBVT	UCC27511ADBVR
LP5912-1.2DRVR	TLV70310DBVR	TPS562210ADDFR	UCC27511ADBVT
LP5912-1.2DRVT	TLV70311DBVR	TPS562210ADDFT	UCC27531D
LP5912-1.5DRVR	TLV70312DBVR	TPS562210DDFR	UCC27531DBVR
LP5912-1.5DRVT	TLV70313DBVR	TPS562210DDFT	UCC27531DBVT
LP5912-1.8DRVR	TLV70315DBVR	TPS562219ADDFR	UCC27531DR
LP5912-1.8DRVT	TLV70318DBVR	TPS562219ADDFT	UCC27532DBVR
LP5912-2.5DRVR	TLV70325DBVR	TPS562219DDFR	UCC27532DBVT
LP5912-2.5DRVT	TLV70327DBVR	TPS562219DDFT	UCC27533DBVR
LP5912-2.8DRVR	TLV70328DBVR	TPS62110RSAR	UCC27533DBVT
LP5912-2.8DRVT	TLV70329DBVR	TPS62110RSARG4	UCC27536DBVR
LP5912-3.0DRVR	TLV70330DBVR	TPS62110RSAT	UCC27536DBVT
LP5912-3.0DRVT	TLV70333DBVR	TPS62110RSATG4	UCC27537DBVR
LP5912-5.0DRVR	TPS27081ADDCR	TPS62111RSAR	UCC27537DBVT
LP5912-5.0DRVT	TPS54227DRCR	TPS62111RSARG4	UCC27538DBVR
SN0603044RSAR	TPS54227DRCT	TPS62111RSAT	UCC27538DBVT
SN1706011DDCR	TPS54228D	TPS62112RSAR	
SN1706011DDCT	TPS54228DR	TPS62112RSARG4	

# Qualification Report

# Approve Date 6-October-2010

#### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TPS51217DSC
ED	Electrical Characterization	Per Datasheet Parameters	Pass
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0
AC	Autoclave, 121C	96 Hours	3/231/0
HBM	ESD - HBM	2000 V	3/9/0
CDM	ESD - CDM	500 V	3/9/0
HTOL	Life Test, 135C	635 Hours	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/231/0
LU	Latch-up	(per JESD78)	3/18/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/18/0

- Qual Device TPS51217DSC is qualified at LEVEL2-260C

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours - The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent FISE options based on an activation energy of 0.7eV . 150C/1 R Hours, and 170C/420 RC
 The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the contact below or your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	PCN ww admin team@list.ti.com

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